

TOSHIBA TRANSISTOR SILICON NPN EPITAXIAL PLANAR TYPE

2SC5317FT

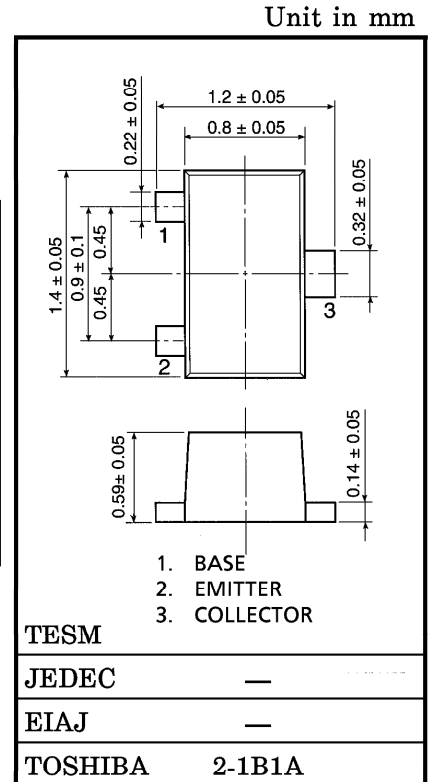
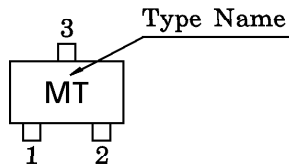
VHF~UHF BAND LOW NOISE AMPLIFIER APPLICATIONS
(CHIP : $f_T = 16$ GHz series)

- Low Noise Figure : $NF = 1.3$ dB ($f = 2$ GHz)
- High Gain : $|S_{21e}|^2 = 9$ dB ($f = 2$ GHz)

MAXIMUM RATINGS ($T_a = 25^\circ\text{C}$)

CHARACTERISTIC	SYMBOL	RATING	UNIT
Collector-Base Voltage	V_{CB0}	8	V
Collector-Emitter Voltage	V_{CE0}	5	V
Emitter-Base Voltage	V_{EB0}	1.5	V
Collector Current	I_C	20	mA
Base Current	I_B	10	mA
Collector Power Dissipation	P_C	100	mW
Junction Temperature	T_j	125	$^\circ\text{C}$
Storage Temperature Range	T_{stg}	-55~125	$^\circ\text{C}$

MARKING



MICROWAVE CHARACTERISTICS ($T_a = 25^\circ\text{C}$)

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Transition Frequency	f_T	$V_{CE} = 3$ V, $I_C = 15$ mA	9	—	—	GHz
Insertion Gain	$ S_{21e} ^2$ (1)	$V_{CE} = 3$ V, $I_C = 15$ mA, $f = 1$ GHz	12	15	—	dB
	$ S_{21e} ^2$ (2)	$V_{CE} = 3$ V, $I_C = 15$ mA, $f = 2$ GHz	6	9	—	
Noise Figure	NF (1)	$V_{CE} = 3$ V, $I_C = 5$ mA, $f = 1$ GHz	—	0.9	1.8	dB
	NF (2)	$V_{CE} = 3$ V, $I_C = 5$ mA, $f = 2$ GHz	—	1.3	2.2	

ELECTRICAL CHARACTERISTICS ($T_a = 25^\circ\text{C}$)

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Collector Cut-off Current	I_{CBO}	$V_{CB} = 8$ V, $I_E = 0$	—	—	1	μA
Emitter Cut-off Current	I_{EBO}	$V_{EB} = 1$ V, $I_C = 0$	—	—	1	μA
DC Current Gain	h_{FE}	$V_{CE} = 3$ V, $I_C = 15$ mA	50	—	250	V
Output Capacitance	C_{ob}	$V_{CB} = 2.5$ V, $I_E = 0$,	—	0.6	—	pF
Reverse Transfer Capacitance	C_{re}	$f = 1$ MHz (Note)	—	0.4	0.85	pF

(Note) : C_{re} is measured by 3 terminal method with Capacitance bridge.

CAUTION

This device electrostatic sensitivity. Please handle with caution.

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